

Muon Chapter

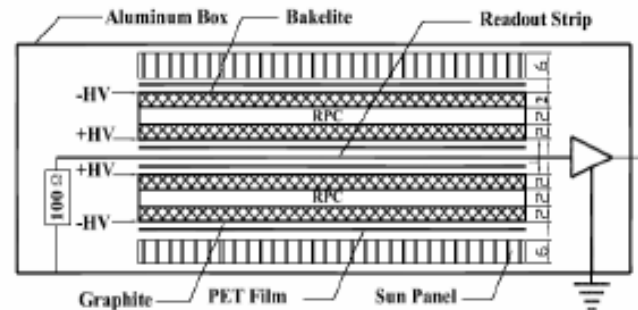
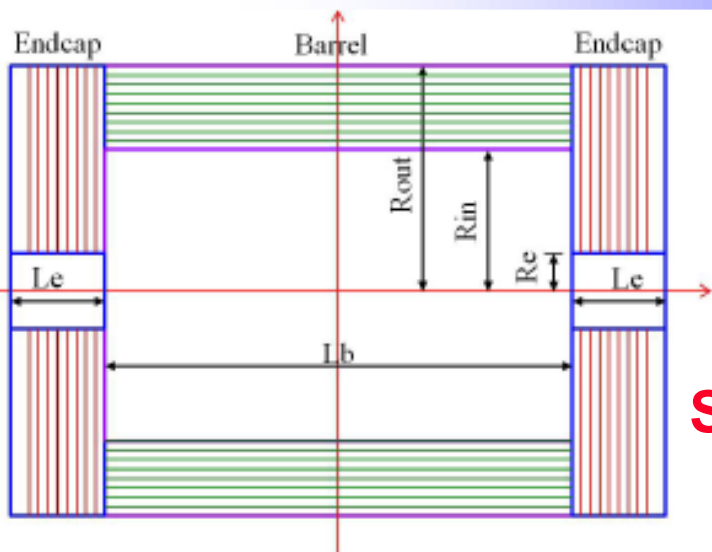
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Muon Chapter

8 Muon system

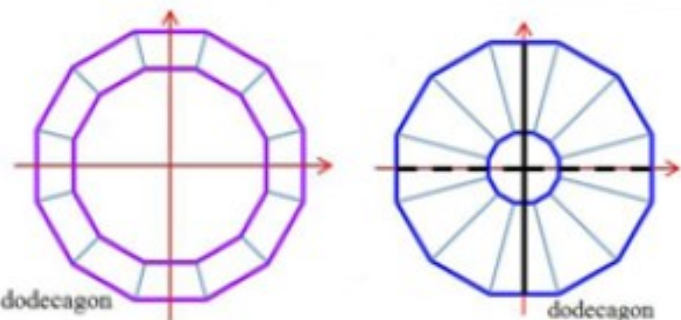
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Muon System Overview



Structure:

- Between magnet iron yoke, outside HCAL
- Cylindrical barrel & two endcap system
- Solid angle coverage: $0.98 * 4\pi$



Technology:

- Bakelite/glass RPC as baseline
- Many other options in consideration
 - μ RWell
 - Micromegas, GEM
 - MDT, Scintillator Strip

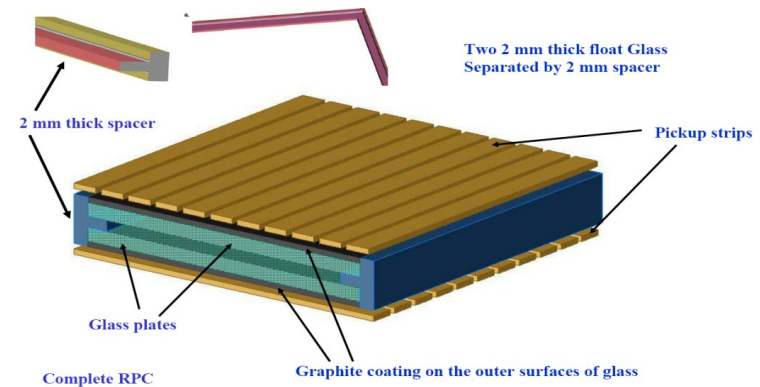
Baseline Design

Parameter	Possible range	Baseline
Lb/2 [m]	3.6 – 5.6	4.0
Rin [m]	3.5 – 5.0	4.4
Rout [m]	5.5 – 7.2	7.0
Le [m]	2.0 – 3.0	2.6
Re [m]	0.6 – 1.0	0.8
Segmentation	8/10/12	12
Number of layers	6 – 10	8
Total thickness of iron	6 – 10 λ ($\lambda = 16.77$ cm)	8 λ (136 cm) (8/8/12/12/16/16/20/20/24) cm
Solid angle coverage	(0.94 – 0.98) $\times 4\pi$	0.98
Position resolution [cm]	$\sigma_{r\phi}$: 1.5 – 2.5 σ_z : 1 – 2	2 1.5
Detection efficiency ($E_\mu > 5$ GeV)	92% – 99%	95%
Fake($\pi \rightarrow \mu$)@30GeV	0.5% – 3%	< 1%
Rate capability [Hz/cm ²]	50 – 100	~60
Technology	RPC μ RWell Micromegas GEM (s)TGC MDT Scintillating strip	RPC (super module, 1 layer readout, 2 layers of RPC)
Total area [m ²]	Barrel Endcap Total	~4450 ~4150 ~8660

Signal efficiency > 95% for muon pT > 4 GeV with 8 layers

Resistive Plate Chamber (RPC)

Parameters	Bakelite	Glass
Bulk resistivity [$\Omega \cdot \text{cm}$]	Normal	$10^{10} \sim 10^{12}$
	Developing	$10^8 \sim 10^9$
Max unit size (2 mm thick) [m]	1.2 \times 2.4	1.0 \times 1.2
Surface flatness [nm]	< 500	< 100
Density [g/cm ³]	1.36	2.4~2.8
Min board thickness [mm]	1.0	0.2
Mechanical performance	Tough	Fragile
Rate capability [Hz/cm ²]	Streamer	100@92% [97]
	Avalanche	10K
Noise rate [Hz/cm ²]	Streamer	< 0.8
		0.05 [99]

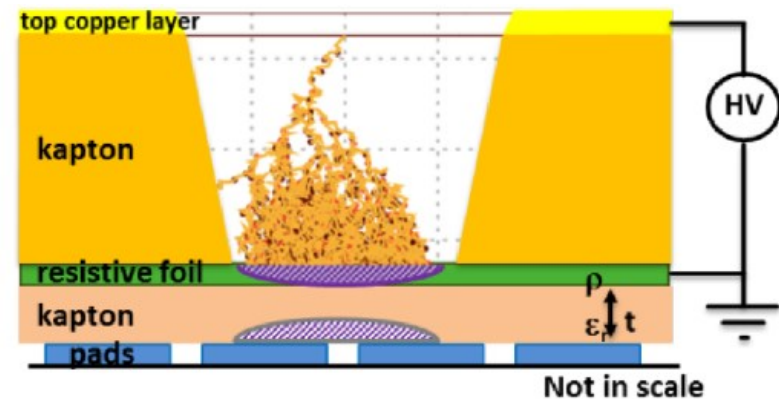
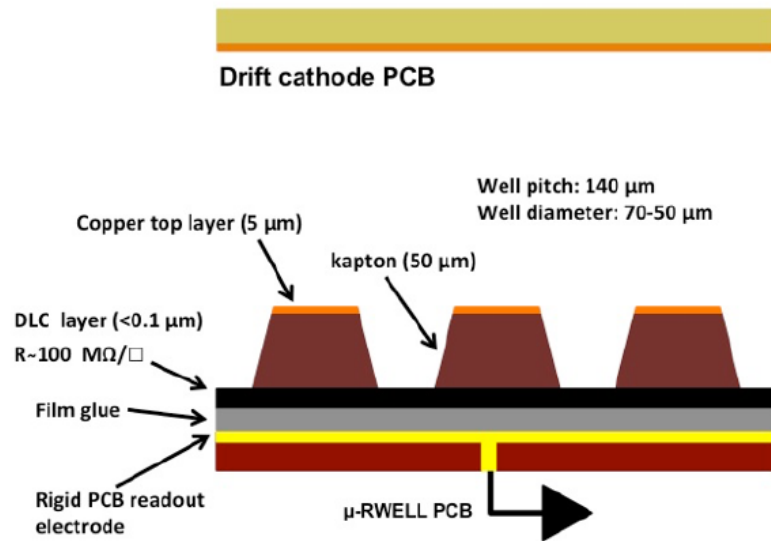


- ✓ **Low cost, easy construction**
- ✓ **Position resolution: 5-10 mm**
- ✓ **Time resolution: ~ 1 ns**

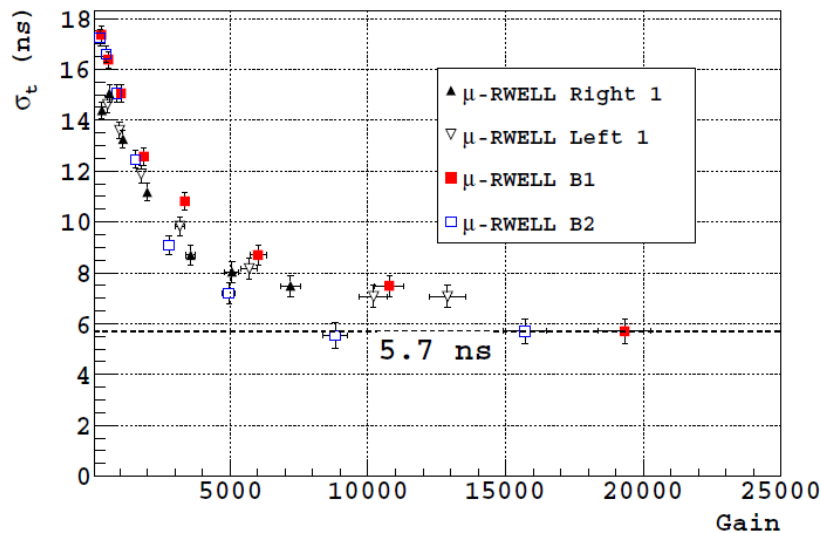
Other Options

Micro-RWell technology

- MPGD with two PCBs: a standard GEM Drift cathode PCB and a μ RWell PCB
- Amplification stage couples directly with readout: low/high rate option



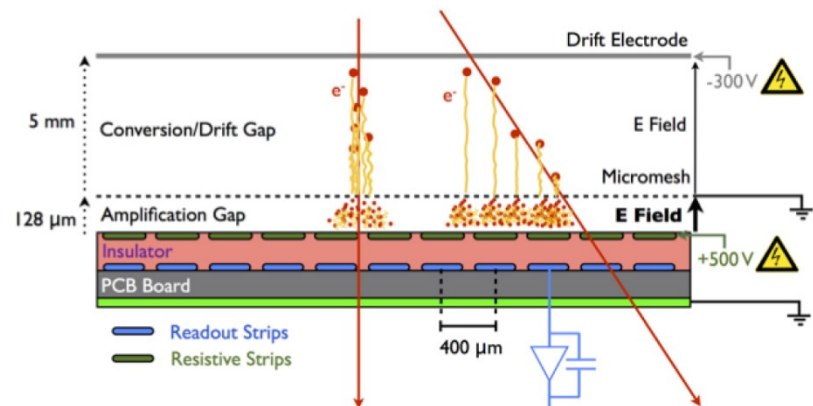
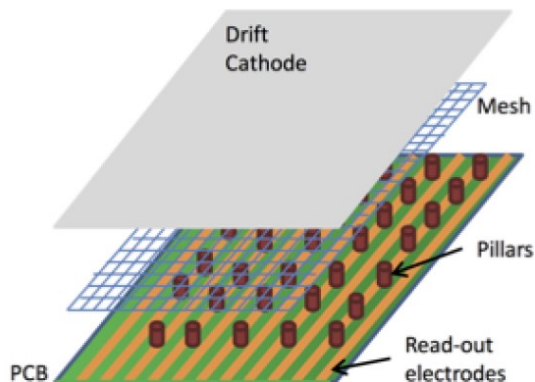
- ✓ Much simpler than many other MPGDs, such as GEMs or MicroMegas
- ✓ Rate capability: a few tens of KHz/cm^2
- ✓ Position resolution: $\sim 60 \mu\text{m}$
- ✓ Time resolution: 5-6 ns



Other Options

Micro Mesh Gaseous Structure (Micromegas)

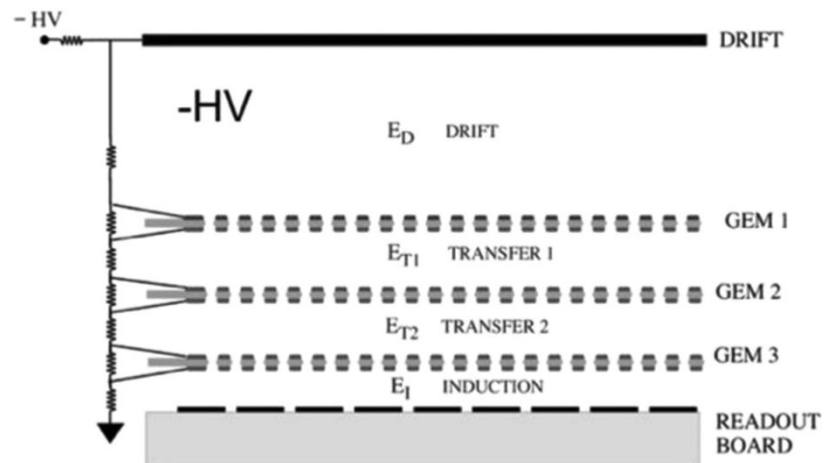
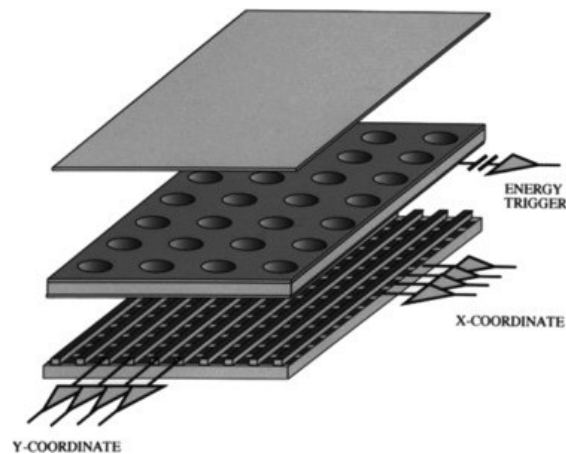
- A planar drift electrode, a gas gap of a few millimeters thickness as conversion and drift region, and a thin metallic mesh typically 100–150 μm distance from the readout electrode as the amplification region.
- Good spatial resolution $< 100 \mu\text{m}$, time resolution $\sim 10\text{ns}$
- High rate capability: $\sim 10\text{MHz}/\text{cm}^2$
- Vulnerability to sparking
- Large active area (10^4m^2) Micromegas still under development



Other Options

Gas Electron Multiplier (GEM) technology

- Gaseous ionization detector using copper-clad Kapton foil (50-70 μm thick) with etched holes (30-50 μm diameter) for gas amplification.
- Very good spatial resolution \sim diameter, time resolution \sim 10-20ns
- High rate capability: \sim 10MHz/cm²
- Vulnerability to sparking
- Complexity of assembly procedure: stretching and gluing GEM foils



Other Options

Monitored Drift Tube (MDT) technology

- **Wire chamber:** an anode wire at center of tube and a metallic cathode (aluminum) with gas in between
- **Good spatial resolution** $\sim 80\mu\text{m}$, **good time resolution** $\sim 10\text{ns}$
- **Rate capability:** $\sim 500\text{Hz}/\text{cm}^2$

Scintillator Strips technology

- **Plastic scintillator material can be extruded into strips longer than 5 m.** Use wave-length shifting (WLS) fibers to shift the light spectrum to match the response of Si photo-diodes (SiPM) or multi pixel photo counters (MPPC)
- **Construct compact and rigid modules with 1-D or 2D readout strip arrays**
- **Spatial resolution** $\sim 3\text{ cm}$, **time resolution** $< 1\text{ ns}$

Ongoing Studies

Muon system as an add-on

- Simulation study with built-in calorimeter / TCMT geometry, also integrated with yoke and magnet system
- Complementary to Calorimeter
 - Effect as a tail catcher / muon tracker (TCMT)
 - JER with/wo TCMT
 - Preliminary test with fast simulation: the level of improvement depends on the energy deposited in the muon detector, ranging from 1% (energy compensation ~ 1GeV) to 8% (energy compensation ~ 10GeV or more)

Non-isolated muon efficiency

- Simulation study using LICH (PFA) muon ID algorithm
- Check muons inside jets

Future R&D

- ✓ **Long-lived particles optimization: explore new physics scenario of long-lived particles and exotic decays. Optimize detector parameters and technologies.**
- ✓ **Layout and geometry optimization: detailed studies on the structure of the segments and modules. The geometry and dimensions need to be optimized together with the inner detectors, in particular the ECAL and the HCAL.**
- ✓ **Gas detectors: Study aging effects, improve long-term reliability and stability.**
- ✓ **All detectors: Improve massive and large area production procedures and readout technologies.**